



Features:

- Multilayer fabrication technology
- -55 to 125°C operating temperature range
- Operating voltage range VM (DC) at 5.5 V to 85 V
- Able to withstand ESD test of IEC-61000-4-2
- Bi-directional clamping characteristic

Description:

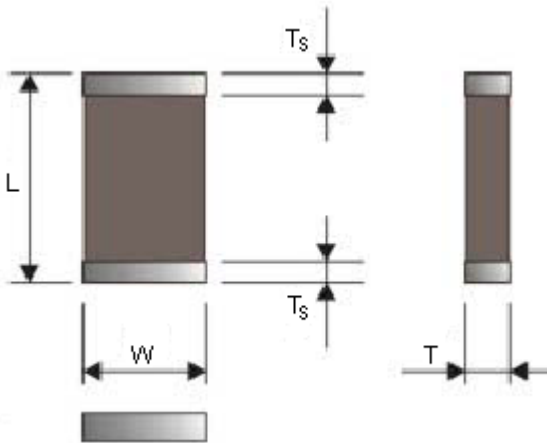
This multilayer chip varistor is a family of transient voltage surge suppression products. Today, electronic circuits are becoming smaller and more sensitive to external interference. These multilayer chip varistors are designed to protect components from destruction of transients and ESD (Electronic Static Discharge). The wide operating voltage and energy range make these multilayer chip varistors suitable for numerous applications on I/O protection, Vcc protection, Keyboard protection, LCD protection, Sensor protection etc. Manufactured by multilayer fabrication technology providing excellent voltage clamping ability and is supplied in leadless, surface mount form, compatible with modern reflow and wave soldering procedures.

Applications:

Protection of cellular phones, PDA, High Speed Data Line etc

ESD Protection for components sensitive to IEC 61000-4-2, Provides Circuit Board Transient Voltage Protection for Transistors

Protection of Video and Audio Ports



Dimensions

Size	VZ0402	VZ0603	VZ0805	VZ1206
L	1 ± 0.1	1.6 ± 0.15	2 ± 0.2	3.2 ± 0.2
W	0.5 ± 0.1	0.8 ± 0.15	1.25 ± 0.2	1.6 ± 0.2
T	0.5 ± 0.1	0.8 ± 0.15	0.8 ± 0.2	0.8 ± 0.1 mm* 1.1 ± 0.2 mm**
Ts	0.25 ± 0.15	0.35 ± 0.15	0.5 ± 0.2	0.65 ± 0.25

Terminal electrode : Ni / Sn electrode

Note: * means VZ1206 5.5 V dc to 22 V dc items

** means VZ1206 26 V dc to 85 V dc items

Multilayer Chip Varistors



Electrical Data

Item	General Specification
Continuous Rating: Steady State Applied Voltage: DC voltage Range (VMDC) AC voltage Range (VMDC RMS)	5.5 V to 85 V 4 V to 60 V
Transient Rating: Non-Repetitive Surge Current (8 / 20is) Non-Repetitive Surge Energy, 10 / 1,000is Waveform, (WTM) Operating Ambient Temperature Range (TA) Storage Temperature Range (TSTG) Temperature Coefficient (ΔV) of clamping Voltage (VC) at Specified Test Current	20 A to 100 A 0.05 J to 1 J -55°C to 125°C -55°C to 150°C <0.01 % / °C

Standard Testing Condition

Unless otherwise specified

Temperature	: 15 to 35°C
Humidity	: 25% RH to 85% RH
Atmospheric Pressure	: 86 kPa to 106 kPa

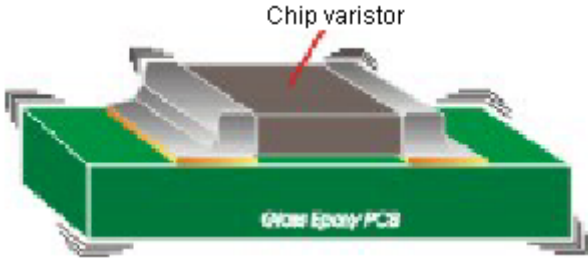
Specifications:

1. Electrical Reliability

Test item	Test Condition / Test Method	Specification															
High temperature storage	+125 \pm 3°C for 1,000 hours Measurement to be made after keeping at room temperature for 24 \pm 2 hours	ΔV at 1 mA <10%															
Low temperature storage	+40 \pm 3°C for 1,000 hours Measurement to be made after keeping at room temperature for 24 \pm 2 hours																
Humidity storage	40 \pm 2°C, 90 to 95% RH for 500 hours Measurement to be made after keeping at room temperature for 24 \pm 2 hours																
Temperature cycles	<p style="text-align: center;">Times : 5 cycles</p> <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Time (minimum)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-55 \pm3</td> <td>30 \pm3</td> </tr> <tr> <td>2</td> <td>Room temperature</td> <td>2 to 3</td> </tr> <tr> <td>3</td> <td>+125°C 3°C</td> <td>30 \pm2</td> </tr> <tr> <td>4</td> <td>Room temperature</td> <td>2 to 3</td> </tr> </tbody> </table> Measurement to be made after keeping at room temperature for 24 \pm 2 hours	Step	Temperature (°C)	Time (minimum)	1	-55 \pm 3	30 \pm 3	2	Room temperature	2 to 3	3	+125°C 3°C	30 \pm 2	4	Room temperature	2 to 3	
Step	Temperature (°C)	Time (minimum)															
1	-55 \pm 3	30 \pm 3															
2	Room temperature	2 to 3															
3	+125°C 3°C	30 \pm 2															
4	Room temperature	2 to 3															
Solderability	Solder temperature : 230 \pm 5°C Immersion time : 2 \pm 0.5 seconds Immersion and emersion rates : 25 mm / s	Minimum 90% electrode shall be covered with solder															
Resistance to Soldering Heat	Pre-heating :120 to 150°C, 60 seconds Solder temperature : 260 \pm 5°C Immersion time : 10 \pm 1 seconds Measurement to be made after keeping at room temperature for 24 \pm 2 hours	ΔV at 1 mA <10% Disappearance of electrode due to immersion into solder shall not exceed 25% of edges of each electrode															

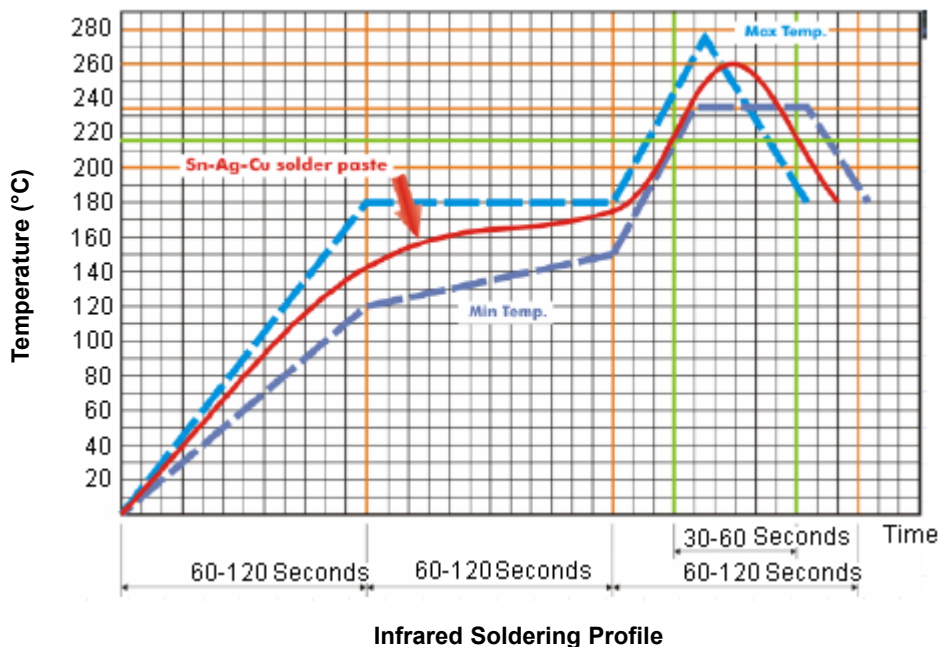
Multilayer Chip Varistors



Test item	Test condition / Test method	Specification
Adhesive Strength of Termination	<p>Solder chip on PCB and applied 0805 / 1206 Series : 10N (1 kgf) for 10 seconds 0402 / 0603 Series : 5N (0.5 kgf) for 10 seconds</p> 	No visible damage
Vibration	<p>Solder chip on PCB Frequency : 10 Hz to 55 Hz to 10 Hz (1 minimum) Oscillation amplitude : 1.5 mm Times : 2 hours in each of three perpendicular direction</p>	
Bending Test	<p>The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of 1 mm per second until the deflection becomes 1 mm and then the pressure shall be maintained for 5 seconds</p>	No visible damage ΔV at 1 mA < 10%

Soldering Condition

Typical examples of soldering processes that provide reliable joints without any damage are given in figure below:



Multilayer Chip Varistors



Caution of Handing

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property

- Aircraft equipment
- Aerospace equipment
- Undersea equipment
- Medical equipment
- Traffic signal equipment
- Applications of similar complexity and / or reliability requirements to the applications listed in the above

Storage Condition

- Products should be used in 6 months from the day of WAL SIN outgoing inspection, which can be confirmed
- Storage environment condition
 - Products should be storage in the warehouse on the following conditions
 - Temperature : -10 to +40°C
 - Humidity : 30 to 70% relative humidity
 - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability
 - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on
 - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on
 - Products should be storage under the airtight packaged condition

Specifications Table

Description	Chip Size L x W (in inches)	Style	Rated Voltage (V dc)	Capacitance Tolerance	Termination	Packing	Part Number
Varistor, 0402, 4 V ac	04 × 02	Multilayer	5.5	Standard	Green Material	Reeled	MCFT000302
Varistor, 0402, 6 V ac			9				MCFT000303
Varistor, 0402, 8 V ac			11				MCFT000304
Varistor, 0402, 11 V ac			14				MCFT000305
Varistor, 0402, 14 V ac			18				MCFT000306
Varistor, 0603, 4 V ac	06 × 03		5.5				MCFT000307
Varistor, 0603, 6 V ac			9				MCFT000308
Varistor, 0603, 11 V ac			14				MCFT000309
Varistor, 0603, 14 V ac			18				MCFT000310
Varistor, 0603, 20 V ac			26				MCFT000311
Varistor, 0603, 25 V ac			30				MCFT000312
Varistor, 0603, 30 V ac	38		MCFT000313				
Varistor, 0805, 4 V ac	08 × 05		5.5				MCFT000314
Varistor, 0805, 6 V ac			9				MCFT000315
Varistor, 0805, 14 V ac			18				MCFT000316

Multilayer Chip Varistors



Specifications Table

Description	Chip Size L x W (in inches)	Style	Rated Voltage (V dc)	Capacitance Tolerance	Termination	Packing	Part Number
Varistor, 0805, 17 V ac	08 × 05	Multilayer	22	Standard	Green Material	Reeled	MCFT000317
Varistor, 0805, 20 V ac			26				MCFT000318
Varistor, 0805, 25 V ac			30				MCFT000319
Varistor, 0805, 30 V ac			38				MCFT000320
Varistor, 0805, 35 V ac			45				MCFT000321
Varistor, 1206, 4 V ac	12 × 06		5.5				MCFT000322
Varistor, 1206, 11 V ac			14				MCFT000323
Varistor, 1206, 14 V ac			18				MCFT000324
Varistor, 1206, 17 V ac			22				MCFT000325
Varistor, 1206, 20 V ac			26				MCFT000326
Varistor, 1206, 25 V ac			30				MCFT000327
Varistor, 1206, 30 V ac			38				MCFT000328
Varistor, 1206, 35 V ac			45				MCFT000329
Varistor, 1206, 40 V ac			56				MCFT000330
Varistor, 1206, 50 V ac			65				MCFT000331
Varistor, 1206, 60 V ac			85				MCFT000332

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